

ModulED Nano Seoul Semiconductor Star LED Cooler ø70mm





Features & Benefits

- The ModuLED modular Nano passive LED coolers are specifically designed for luminaires using the Seoul Semiconductor LED COB. Mechanical compatibility with direct mounting of the LED modules to the LED cooler and thermal performance matching the lumen packages.
- For spot and downlight designs from 600 to 3,000 lumen
- Thermal resistance range Rth 1.8 2.2°C/W
- Modular design with mounting holes foreseen for direct mounting of Seoul Semiconductor ZC 6, ZC 12, ZC 18, ZC 25, ZC 40 COB LED, direct mounting or with Zhaga Book 3 / Book 11 LED holder.
- Diameter 70mm Standard height 50mm & 80mm
 Other heights on request
- Extruded from highly conductive aluminum



Order Information

ZZ Zhaga



SEOUL SEMICONDUCTOR

Example: ModuLED Nano 7050-B

ModuLED Nano 70 1 - 2

1 Height (mm)

2 Anodising Color B - Black

C - Clear

ModulED Nano is designed in this way

that you can mount various LED modules on the same LED cooler

Simple mounting with self tapping screws

Recommened screw force 6lb/in

Screws are avaliable from MechaTronix





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Product Details



^{*1 3}D files are avaliable in ParaSolid, STP and IGS on request

To calculate the dissipated power please use the following formula: $Pd = Pe \times (1-\eta L)$

Pd - Dissipated power

Pe - Electrical power

ηL = Light effciency of the LED module

Notes:

- MechaTronix reserves the right to change products or specifications without prior notice.
- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MechaTronix.



^{*2} The thermal resistance Rth is determined with a calibrated heat source of 30mm x 30mm central placed on the heat sink, Tamb 40° and an open environment. Reference data @ heat sink to ambient temperature rise Ths-amb 50°C

The thermal resistance of a LED cooler is not a fix value and will vary with the applied dissipated power Pd

^{*3} Dissipated power Pd. Reference data @ heat sink to ambient temperature rise Ths-amb 50°C

The maximal dissipated power needs to be verified in function of required case temperature Tc or junction temperature Tj and related to the estimated ambient temperature where the light fixture will be placed

Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module



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Mounting Options

The ModuLED modular Nano passive LED coolers are standard foreseen from a variety of mounting holes which allow direct mounting of LED engines, COB's and secondary optics on the LED heat sink.

In this way mechanical afterwork and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED coolers.

Below you find an overview of Seoul Semiconductor COB's which standard fit on the ModuLED Nano LED cooler.

MechaTronix performs thermal validation tests on each of the LED modules mounted on the LED cooler and publishes this data in the LED brand thermal validation reports.

For a full overview of available LED coolers for Seoul Semiconductor LEDs, please refer to the Seoul Semiconductor LED cooler overview on www.led-heatsink.com/Download.php or scan the QR code here.



Seoul Semiconductor LED COB

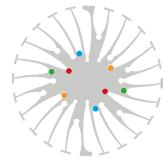


SEOUL SEMICONDUCTOR

The new Seoul Semiconductor ZC series Chip-On-Board (COB) LED Arrays offer high lumen density and efficacies of up to 140lm/W in a single, easy-to-use LED component family. Available in all major color temperatures from 2700K up to 6000K, these high flux packages deliver system level performance of 700 lumens to over 6,000 lumens. The new ZC series family is available in a single 3-step MacAdam Ellipse binning, ensuring excellent color consistency with minimum CRI options of 70, and 80 combining high quality of light with high efficacy.

Mounting indicator marks overview

MechaTronix recommends the use of a high thermal conductive interface between the LED module and the LED cooler. Either thermal grease, a thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended. Thermal pads or phase change thermal pads can be preapplied from MechaTronix.







Seoul Semiconductor ZC 6 LED COB

Model names

- SDW01F1C
- SDW81F1C
- SDW91F1C

Mounting

- Direct mounting with 2 self tapping screws M3 x 6mm Red indicator marks
- With spotlight connector
 BJB Spotlight connector 47.319.6060
 Mounting with 2 self tapping screws M3 x 8mm
- Orange indicator marks

Seoul Semiconductor ZC 12 / ZC 18 LED COB





Model names

- SDW02F1C
- SDW02F1C
- SDW92F1C
- SDW03F1C
- SDW83F1C
- SDW93F1C

Mounting

- Direct mounting with 2 self tapping screwsM3 x 6mm
 Blue indicator marks
- Blue indicator marks

 With Zhaga Book 3 LED holder

 BJB Spotlight connector 47.319.2020
- TE Connectivity Lumawise type Z50 2213254-1
 TE Connectivity Lumawise type Z50 2213254-2
 Mounting with 2 self tapping screwsM3 x 8mm
- Green indicator marks





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Mounting Options





Seoul Semiconductor ZC 25/40 LED COB

Model names

• SDW04F1C

• SDW84F1C

• SDW94F1C

• SDW05F1C

• SDW85F1C • SDW95F1C Mounting

With Zhaga Book 3 LED holder
 BJB Spotlight connector 47.319.2030
 Mounting with 2 self tapping screws M3 x 8mm
 Green indicator marks



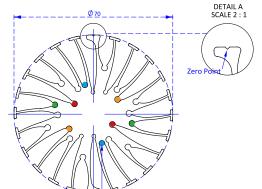


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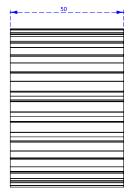




Drawings & Dimensions



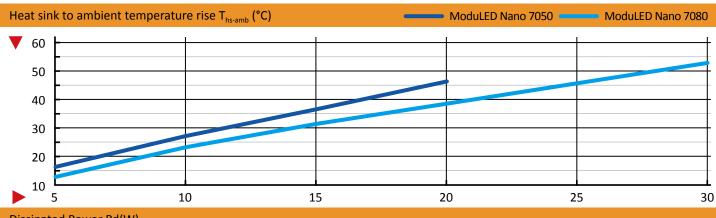
For M3 self-tapping screws Recommended screw force 6lb/in





Thermal Data

Pd = Pe x (1-ηL)			LED Light efficiency, ηL (%)			Heat sink to ambient thermal resistance R _{hs-amb} (°C/W)		Heat sink to ambient temperature rise T _{hs-amb} (°C)	
			17%	20%	25%	ModuLED Nano 7050	ModuLED Nano 7080	ModuLED Nano 7050	ModuLED Nano 7080
Dissipated Power Pd(W)	5	Electrical Power Pe(W)	6.0	6.3	6.7	3.10	2.70	16	13
	10		12.0	12.5	13.3	2.70	2.30	27	23
	15		18.0	18.8	20.0	2.40	2.10	36	31
	20		24.0	25.0	26.7	2.30	1.90	46	39
	30		36.1	37.5	40.0	_	1.80	_	53



Dissipated Power Pd(W)

